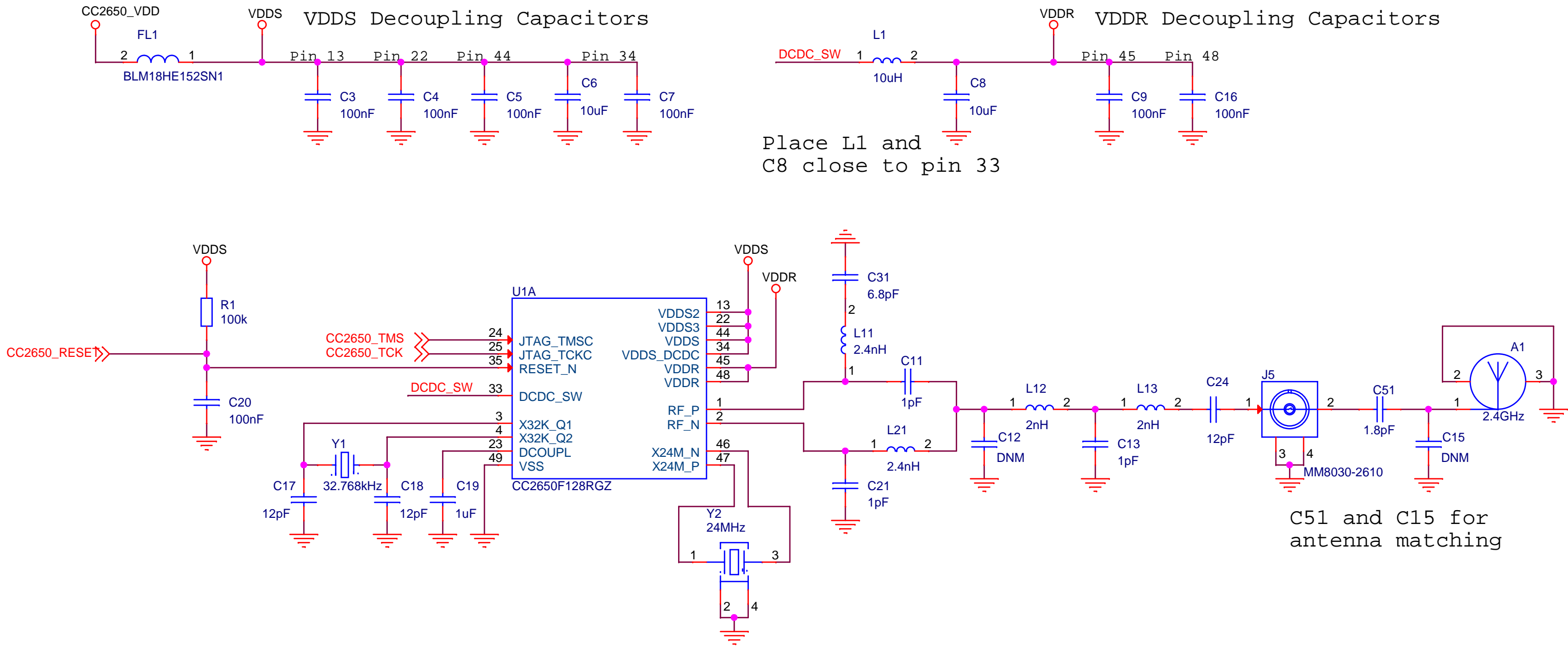


CC2650 RF



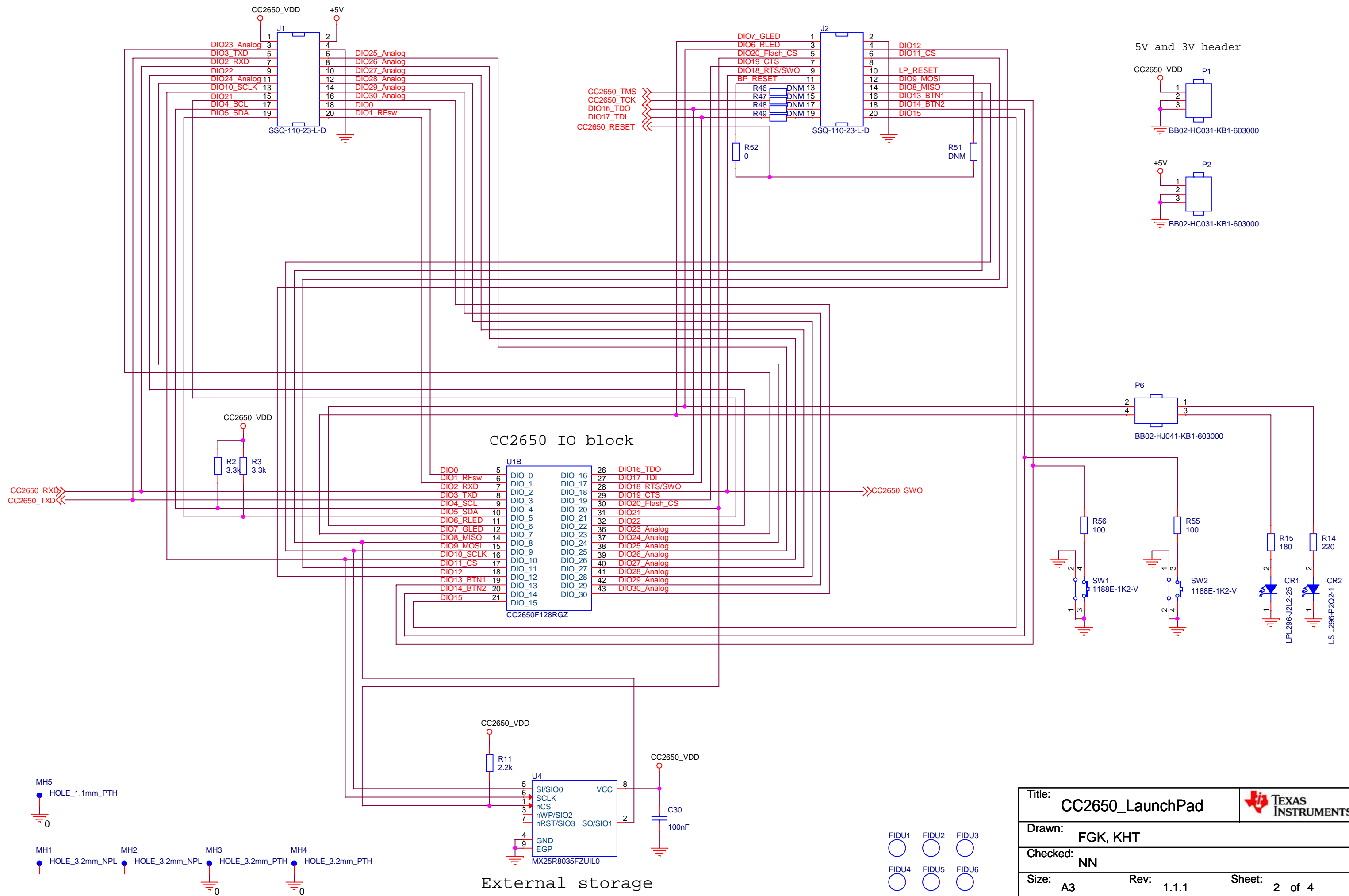
Place L1 and C8 close to pin 33

C51 and C15 for antenna matching

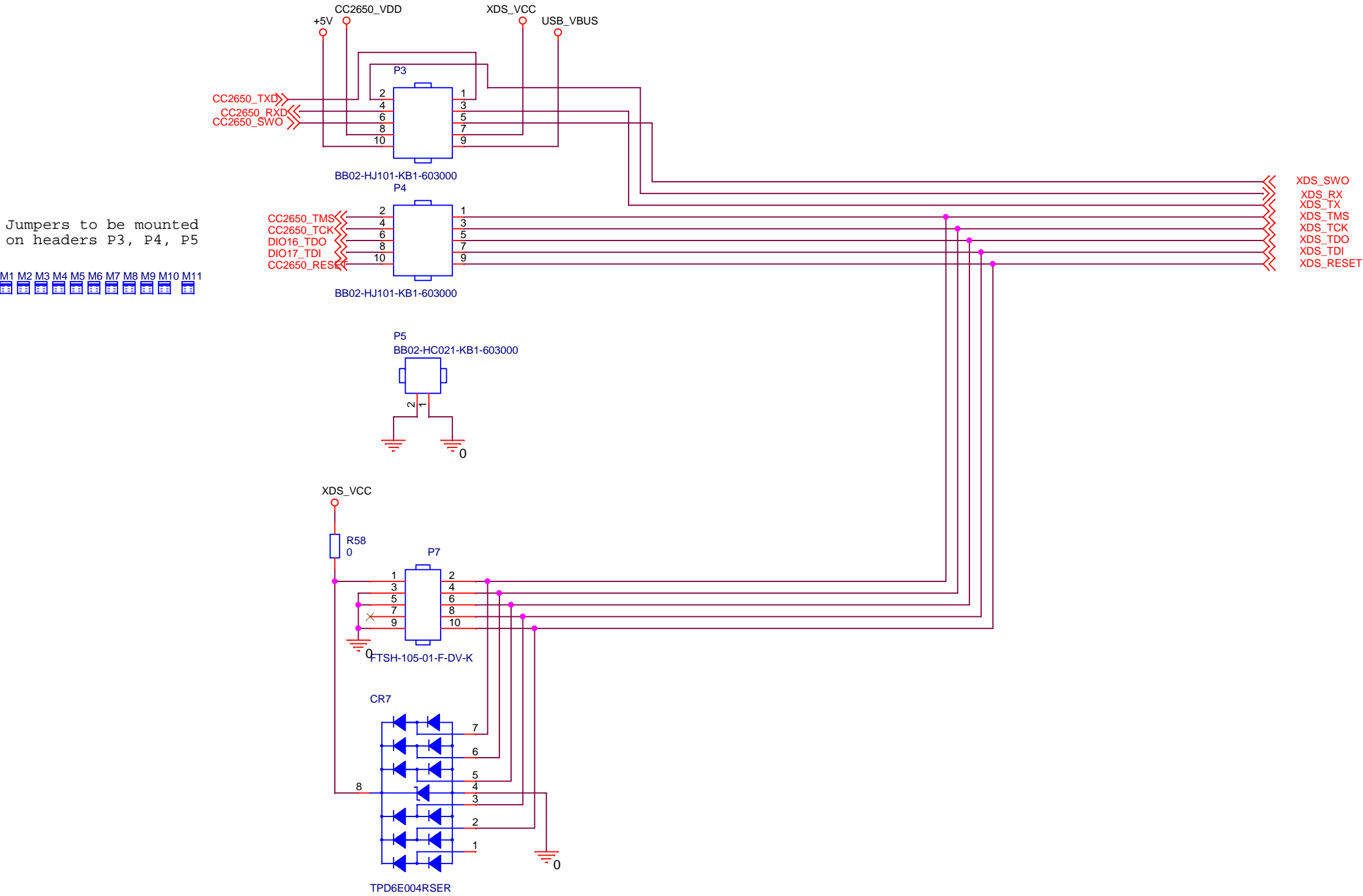
CC2650 IO block placed on page 2.


Title: CC2650_LaunchPad			
Drawn: FGK, KHT			
Checked: NN			
Size: A4	Rev: 1.1.1	Sheet: 1	of 4
Date: Monday, October 26, 2015			

BoosterPack Headers and Peripherals

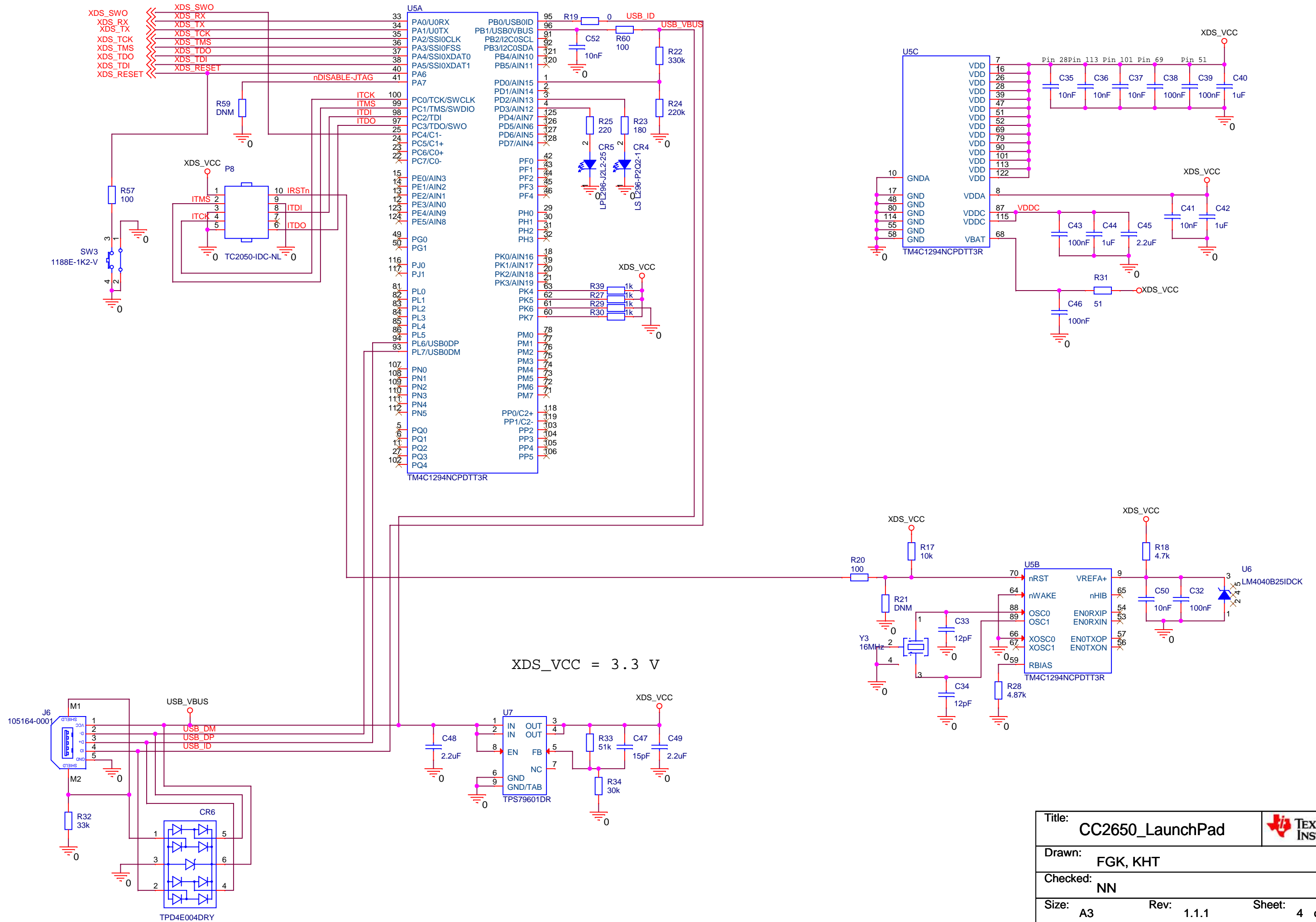


XDS110 Debugger to CC2650 / External Target Interface



Title: CC2650_LaunchPad			
Drawn: FGK, KHT			
Checked: NN			
Size: A3	Rev: 1.1.1	Sheet: 3 of 4	
Date: Monday, October 26, 2015			

XDS110 Debugger



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